

HSU88

Silicon Schottky Barrier Diode for Detector and Mixer

REJ03G0140-0800Z
(Previous: ADE-208-077G)
Rev.8.00
Nov.06.2003

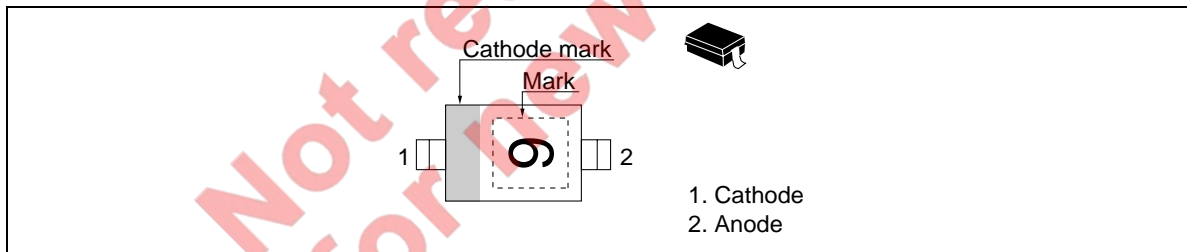
Features

- Low capacitance. (C = 0.8 pF max)
- Low forward voltage.
- Ultra small Resin Package (URP) is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Code
HSU88	9	URP

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V _R	10	V
Average rectified current	I _O	15	mA
Junction temperature	T _j	125	°C
Storage temperature	T _{stg}	-55 to +125	°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	V _{F1}	0.35	—	0.42	V	I _F = 1 mA
	V _{F2}	0.50	—	0.58		I _F = 10 mA
Reverse current	I _{R1}	—	—	0.2	μA	V _R = 2 V
	I _{R2}	—	—	10		V _R = 10 V
Capacitance	C	—	—	0.8	pF	V _R = 0 V, f = 1 MHz
ESD-Capability *1	—	30	—	—	V	C = 200 pF, R = 0 Ω, Both forward and reverse direction 1 pulse.

Notes: 1. Failure criterion ; I_R ≥ 0.4 μA at V_R = 2 V

Main Characteristics

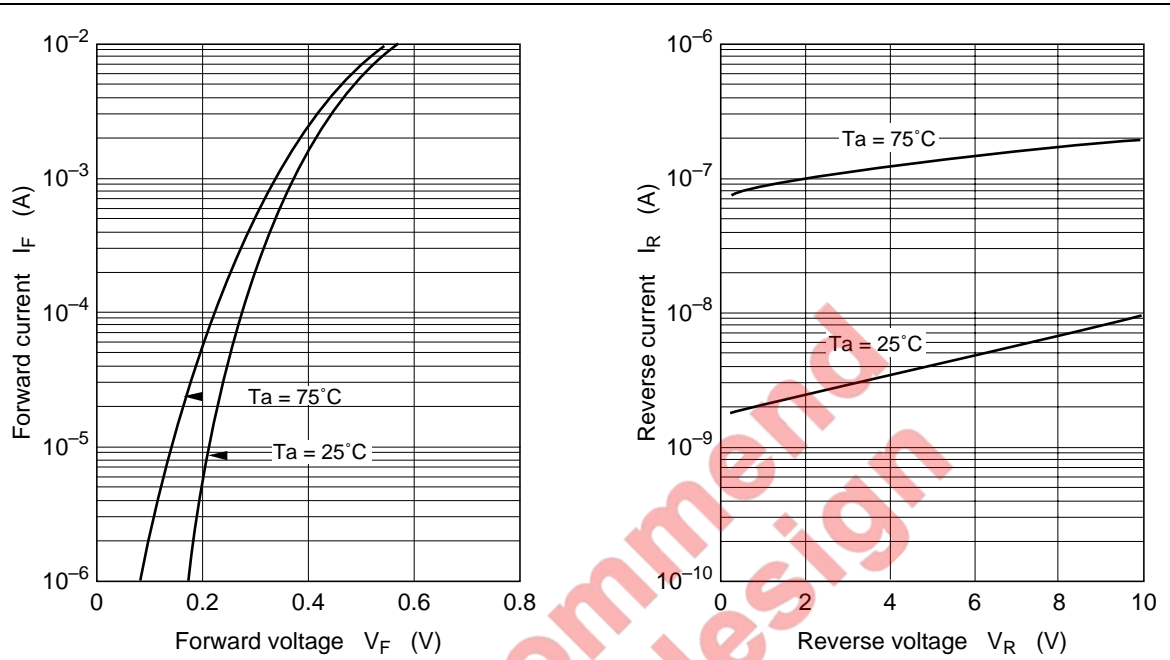


Fig.1 Forward current vs. Forward voltage

Fig.2 Reverse current vs. Reverse voltage

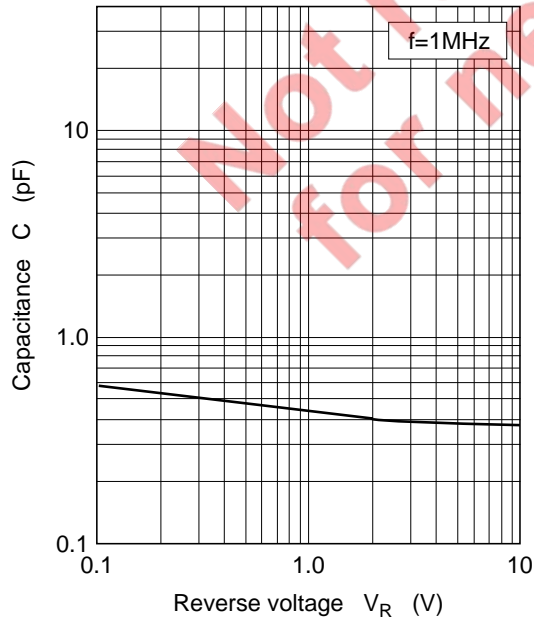
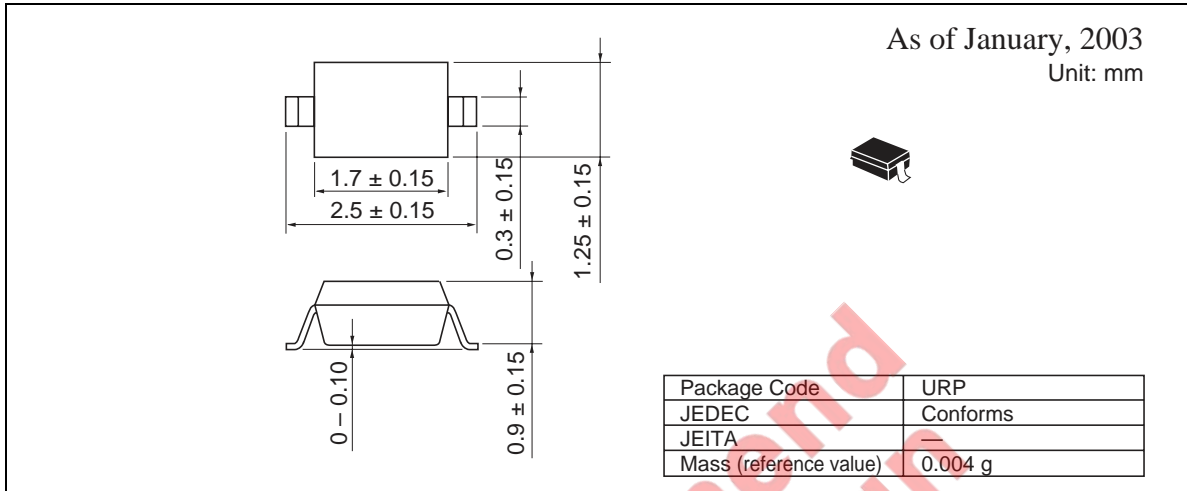


Fig.3 Capacitance vs. Reverse voltage

Package Dimensions



Not recommended for new designs

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April 1st, 2010
Renesas Electronics Corporation

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